BOURNS®

Certificate for RoHS Compliant Products

Bourns, Inc. certifies, as of this date, the products listed below ("Products") are designated as conforming to the requirements of the European Union's Restrictions on use of Certain Hazardous Substances in Electrical and Electronic Equipment Directive, 2011/65/EU (commonly called "RoHS2") and amendment of Annex II on March 31, 2015, 2015/863.

The information presented is based on Bourns' understanding of the directives and Bourns' knowledge of the materials that are used in the Products as of the date of disclosure, which, in some cases, is based on information provided by third parties.

Applies to the following series:

SMF4L; SMF4L-Q	15KPA-SD; 1.5KPA-SD-Q	CD214A-RS1x	CD1408
SMAJ; SMAJ-Q	1.5SMC; 1.5SMC-Q	CD214A-S1x	CD2320
SMBJ; SMBJ-Q	CD214A-T	CD214B-F/FSxx	CDKBP
SMCJ; SMCJ-Q	CD214B-T	CD214B-R	CDNBS04
SMLJ; SMLJ-Q	CD214C-T	CD214B-S2x	CD-DFxxS/SL
SMA6J; SMA6J-Q	CD214L-T	CD214B-S3x	CDMBLxxxS/SL
5.0SMDJ; 5.0SMDJ-Q	CD214A-F	CD214C-F	CDMMBL
SM8SF; SM8SF-Q	CD214A-FS	CD214C-FSxx	P4SMA; P4SMA-Q
1.5SMBJxxA	CD214A-R	CD214C-S3x	P6SMB; P6SMB-Q
1.5SMBJxxCA	CD214A-R12000R		
·	·	RoHS Maximum	
estricted Substances		Concentration Value (MCV) (ppm)*	

	KOTIS Maximum	
Restricted Substances	Concentration Value (MCV) (ppm)*	
Cadmium (Cd)	100	
Lead (Pb)	1,000	
Mercury (Hg)	1,000	
Hexavalent Chromium (Cr ⁺⁶)	1,000	
Polybrominated biphenyls (PBB)	1,000	
Polybrominated diphenyl ethers (PBDE)	1,000	
Bis(2-ethylhexyl)phthalate (DEHP)	1,000	
Butyl benzyl phthalate (BBP)	1,000	
Dibutyl phthalate (DBP)	1,000	
Diisobutyl phthalate (DIBP)	1,000	

* Maximum limit does not apply to applications covered by RoHS exemptions. MCV is based on homogeneous materials as defined in the RoHS Directive.

Exemptions used (if box is checked):

6a. Lead as an alloying element in steel containing up to 0.35% lead by weight

6b. Lead as an alloying element in aluminum containing up to 0.4% lead by weight

6c. Lead as an alloying element as a copper alloy containing up to 4% lead by weight.

7a. Lead in high melting temperature type solders (i.e., lead-based alloys containing more than 85% by weight or more lead).

7(c)-I. Electrical & electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors.

Signature

Liam Heading, Product Line Manager

Date: June 19, 2024 CD3

General Information: The information provided herein is to the best of Bourns, Inc. knowledge and belief. To the extent that Bourns is relying on information provided by third parties, Bourns makes no warranty as to the accuracy or completeness of such information.